

SLLS201G-MAY 1995-REVISED MAY 2005

Vcc

15 **4**A

14 🛛 4Y

13 4Z

G

1 3Z

3Y

9 3A

**D OR NS PACKAGE** 

(TOP VIEW)

16

12

11

10

1A [

1Y 🛛 2

1Z 🛙 3

G**∏**4

2Z 🛛 5

2Y 🛛 6

2A 🛛 7

GND [ ß

### FEATURES

- Switching Rates up to 32 MHz
- **Operate From a Single 3.3-V Supply**
- Propagation Delay Time ... 8 ns Typ
- Pulse Skew Time . . . 500 ps Typ
- High Output-Drive Current . . . ±30 mA
- Controlled Rise and Fall Times ... 3 ns Typ
- Differential Output Voltage With 100- $\Omega$ Load . . . 1.5 V Typ
- **Ultra-Low Power Dissipation** 
  - dc, 0.3 mW Max
  - 32 MHz All Channels (No Load), 385 mW Typ
- Accept 5-V Logic Inputs With 3.3-V Supply
- Low-Voltage Pin-to-Pin Compatible Replacement for AM26C31, AM26LS31, MB571
- **High Output Impedance in Power-Off** Condition
- **Driver Output Short-Protection Circuit**
- **Package Options Include Plastic** Small-Outline (D, NS) Packages

# **DESCRIPTION/ORDERING INFORMATION**

The AM26LV31C and AM26LV31I are BiCMOS quadruple differential line drivers with 3-state outputs. They are designed to be similar to TIA/EIA-422-B and ITU Recommendation V.11 drivers with reduced supply-voltage range.

The devices are optimized for balanced-bus transmission at switching rates up to 32 MHz. The outputs have very high current capability for driving balanced lines such as twisted-pair transmission lines and provide a high impedance in the power-off condition. The enable function is common to all four drivers and offers the choice of active-high or active-low enable inputs. The AM26LV31C and AM26LV31I are designed using Texas Instruments proprietary LinIMPACT-C60<sup>™</sup> technology, facilitating ultra-low power consumption without sacrificing speed. These devices offer optimum performance when used with the AM26LV32 guadruple line receivers.

The AM26LV31C is characterized for operation from 0°C to 70°C. The AM26LV31I is characterized for operation from -45°C to 85°C

T <sub>A</sub>	PACKAGE <sup>(1)</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING		
			AM26LV31CD	AM26LV31C		
0°C to 70°C	SOIC – D	Tape and reel	AM26LV31CDR	AIVIZOLV31C		
0°C to 70°C	SOIC – NS	Topo and real	AM26LV31CNS			
		Tape and reel	AM26LV31CNSR			
	0010 0	-	AM26LV31ID			
4500 to 0500	SOIC – D Tape and reel		AM26LV31IDR	AM26LV31I		
–45°C to 85°C		Tone and real	AM26LV31INS	261 \/241		
	SOIC – NS Tape and reel		AM26LV31INSR	26LV31I		

#### ORDERING INFORMATION

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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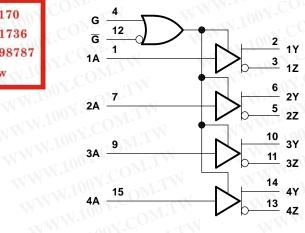
		TONCHON TABLE				
INPUT	ENA	BLES	OUTF	PUTS		
A	G	G	Y	Z		
H	H	X	HI	L		
CAL LAN	H	X	CO'L TY	н	N	
OMH	Х	WW1	COH	L		
NLTY	х	± 10	- LNL-	н		
X	L	H.	Z	Z		

LOGIC DIAGRAM (POSITIVE LOGIC)

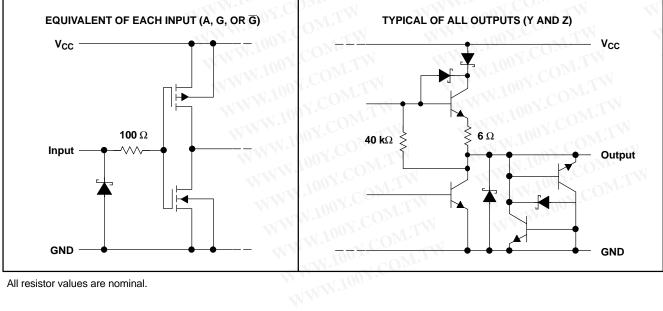
### FUNCTION TABLE<sup>(1)</sup>

(1) H = high level, L = low level, X = irrelevant, Z = high impedance (off)

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## SCHEMATIC (EACH DRIVER)



All resistor values are nominal.

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# Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

	WW.10 CONT.	WWW. MON.COM	MIN	MAX	UNIT	
V <sub>CC</sub>	Supply voltage range <sup>(2)</sup>	CONT.	-0.3	6	V	
VI	Input voltage range	Wing 1001. OMIN	-0.3	6	V	
Vo	Output voltage range	WW 100Y.CO.ITW	-0.3	6	V	
0	Pooleono thermal impedance (3)	D package	ALW N.	73	°C/W	
$\theta_{JA}$	Package thermal impedance <sup>(3)</sup>	NS package	.WW.L	64	C/VV	
	Lead temperature	1,6 mm (1/16 in) from case for 10 s		260	°C	
T <sub>stg</sub>	Storage temperature range	TW WWWWWWWWWW	-65	150	°C	

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

All voltage values are with respect to GND. (2)

(3) The package thermal impedance is calculated in accordance with JESD 51-7.

#### **Recommended Operating Conditions**

	WW TOOY.C	WITH	WWW JIOOX.CO	MIN	NOM	MAX	UNIT
$V_{CC}$	Supply voltage	WIN.	WWW. ONY.CO.	3	3.3	3.6	V
VIH	High-level input voltage	COM.1	WW.IV CO	2		WIN	V
V <sub>IL</sub>	Low-level input voltage		W.1001.	M	-1	0.8	V
I <sub>OH</sub>	High-level output current	WTN	WW 100Y.C	TIM		-30	mA
I <sub>OL</sub>	Low-level output current	V.CON. TW	WWW. OOX.	JON T	N	30	mA
т	Operating free air temperature	AM26LV31C	WW.IVO	<b>CO</b> 0		70	°C
I <sub>A</sub>	Operating free-air temperature AM26LV3		W 1001	-45		85	

#### **Electrical Characteristics**

over recommended operating supply-voltage and free-air temperature ranges (unless otherwise noted)

	PARAMETER	TEST C	MIN	TYP <sup>(1)</sup>	MAX	UNIT	
V <sub>IK</sub> Input clamp voltage		l <sub>l</sub> = 18 mA	1001.0	M.T.Y	-1.5	V	
V <sub>OH</sub>	High-level output voltage	$V_{IH} = 2 V$ ,	I <sub>OH</sub> = -12 mA	1.85	2.3	N	V
V <sub>OL</sub>	Low-level output voltage	$V_{IL} = 0.8 V,$	I <sub>OH</sub> = 12 mA	.105	0.8	1.05	V
VoD Differential output voltage <sup>(2)</sup>		1001.001	LT.	0.95	1.5		V
V <sub>OC</sub>	Common-mode output voltage	R <sub>1</sub> = 100 Ω		1.3	1.55	1.8	V
$\Delta  V_{OC} $	Change in magnitude of common-mode output voltage <sup>(2)</sup>			VI.100	Y.COF	±0.2	V
IO	Output current with power off	$V_0 = -0.25 \text{ V or } 6 \text{ V},$	$V_{CC} = 0$	10	01.0	±100	μA
I <sub>OZ</sub>	Off-state (high-impedance state) output current	$V_0 = -0.25$ V or 6 V,	$G = 0.8 V \text{ or } \overline{G} = 2 V$	NVV.	00Y.CC	±100	μA
I <sub>H</sub>	High-level input current	V <sub>CC</sub> = 0 or 3 V,	V <sub>I</sub> = 5.5 V		1001.0	10	μA
ΙL	Low-level input current	V <sub>CC</sub> = 3.6 V,	V <sub>1</sub> = 0	WWW	. Yoo	-10	μΑ
I <sub>OS</sub>	Short-circuit output current	V <sub>CC</sub> = 3.6 V,	$V_0 = 0$	VIII	1.700	-200	mA
I <sub>CC</sub>	Supply current (all drivers)	$V_{I} = V_{CC}$ or GND,	No load	N.		100	μΑ
C <sub>pd</sub>	Power-dissipation capacitance (all drivers) <sup>(3)</sup>	No load	DOX.COM.TW		160		pF

(1) All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ . (2)  $\Delta |V_{OD}|$  and  $\Delta |V_{OC}|$  are the changes in magnitude of  $V_{OD}$  and  $V_{OC}$ , respectively, that occur when the input is changed from a high level to a low level.

 $C_{pd}$  determines the no-load dynamic current consumption.  $I_S = C_{pd} \times V_{CC} \times f + I_{CC}$ (3)

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## AM26LV31C, AM26LV31I LOW-VOLTAGE HIGH-SPEED QUADRUPLE DIFFERENTIAL LINE DRIVERS SLLS201G-MAY 1995-REVISED MAY 2005



	PARAMETER	TEST CONDITIONS	MIN	TYP <sup>(1)</sup>	MAX	UNIT
t <sub>PLH</sub>	Propagation delay time, low- to high-level output	See Figure 2	4	8	12	ns
t <sub>PHL</sub>	Propagation delay time, high- to low-level output	1001. OM.TW	4	8	12	ns
t <sub>t</sub>	Transition time (t <sub>r</sub> or t <sub>f</sub> )	TW JOY.CO. TW	A M	3	1.0-	ns
SR	Slew rate, single-ended output voltage	See Note <sup>(2)</sup> and Figure 2	WW	0.3	1.1	V/ns
t <sub>PZH</sub>	Output-enable time to high level	See Figure 3		10	20	ns
t <sub>PZL</sub>	Output-enable time to low level	See Figure 4	A.	10	20	ns
t <sub>PHZ</sub>	Output-disable time from high level	See Figure 3	1	10	20	ns
t <sub>PLZ</sub>	Output-disable time from low level	See Figure 4		10	20	ns
t <sub>sk(p)</sub>	Pulse skew	f = 32  MHz, See Note <sup>(3)</sup>		0.5	1.5	ns
t <sub>sk(o)</sub>	Skew limit	f = 32 MHz		M.	1.5	ns
t <sub>sk(lim)</sub>	Skew limit (device to device)	f = 32  MHz, See Note <sup>(4)</sup>	N	MM	3	ns

All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.  
Slew rate is defined by:  
$$SR = \frac{90\%(V_{OH} - V_{OL}) - 10\%(V_{OH} - V_{OL})}{t}$$
, the differential slew rate of V<sub>OD</sub> is 2 × SR.

(3)

WWW.100Y.COM.T Pulse skew is defined as the  $|t_{PLH} - t_{PHL}|$  of each channel of the same device. Skew limit (device to device) is the maximum difference in propagation delay times between any two channels of any two devices. (4)WWW.100Y.COM 100X.COM.T

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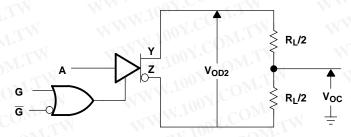
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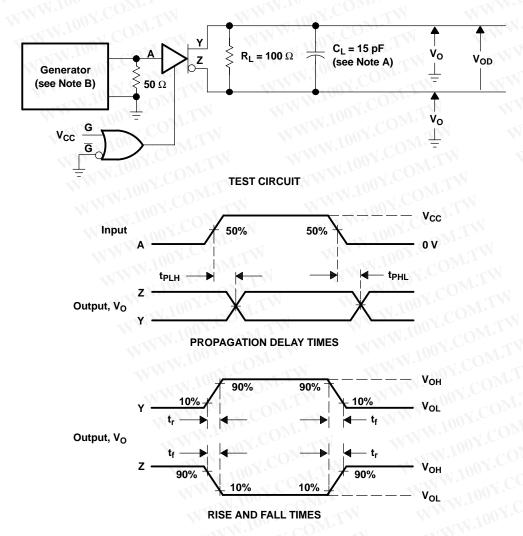


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#### PARAMETER MEASUREMENT INFORMATION







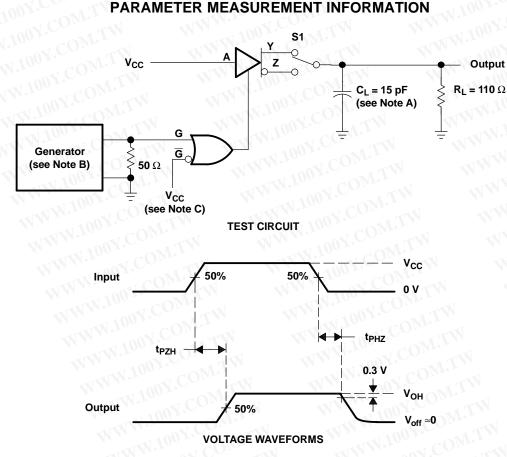
- NOTES: A. CL includes probe and jig capacitance.
  - B. The input pulse is supplied by a generator having the following characteristics: PRR = 32 MHz,  $Z_O \approx 50 \Omega$ , 50% duty cycle,  $t_r$  and  $t_f \le 2$  ns.

Figure 2. Test Circuit and Voltage Waveforms, t<sub>PHL</sub> and t<sub>PLH</sub>

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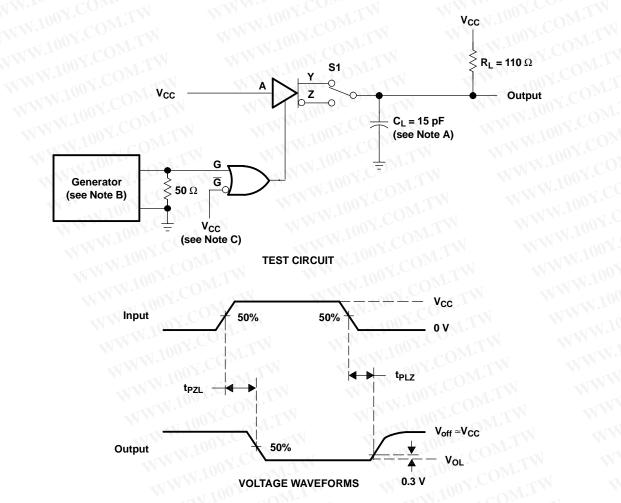


- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz,  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r$  and  $t_f$  (10% to 90%)  $\leq$  2 ns.
  - C. To test the active-low enable  $\overline{G}$ , ground G and apply an inverted waveform to  $\overline{G}$ .

Figure 3. Test Circuit and Voltage Waveforms, t<sub>PZH</sub> and t<sub>PHZ</sub>

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#### PARAMETER MEASUREMENT INFORMATION

NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

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- B. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz,  $Z_0$  = 50  $\Omega$ , 50% duty cycle,  $t_r$  and  $t_f$  (10% to 90%)  $\le$  2 ns.
- C. To test the active-low enable  $\overline{G}$ , ground G and apply an inverted waveform to  $\overline{G}$ .

WWW.100Y.COM.TW Figure 4. Test Circuit and Voltage Waveforms, t<sub>PZL</sub> and t<sub>PLZ</sub>

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# PACKAGE OPTION ADDENDUM

18-Jul-2006

## **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
AM26LV31CD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
AM26LV31CDE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
AM26LV31CDR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
AM26LV31CDRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
AM26LV31CNSLE	OBSOLETE	SO	NS	16		TBD	Call TI	Call TI
AM26LV31CNSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
AM26LV31CNSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
AM26LV31ID	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
AM26LV31IDE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
AM26LV31IDR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
AM26LV31IDRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
AM26LV31INSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
AM26LV31INSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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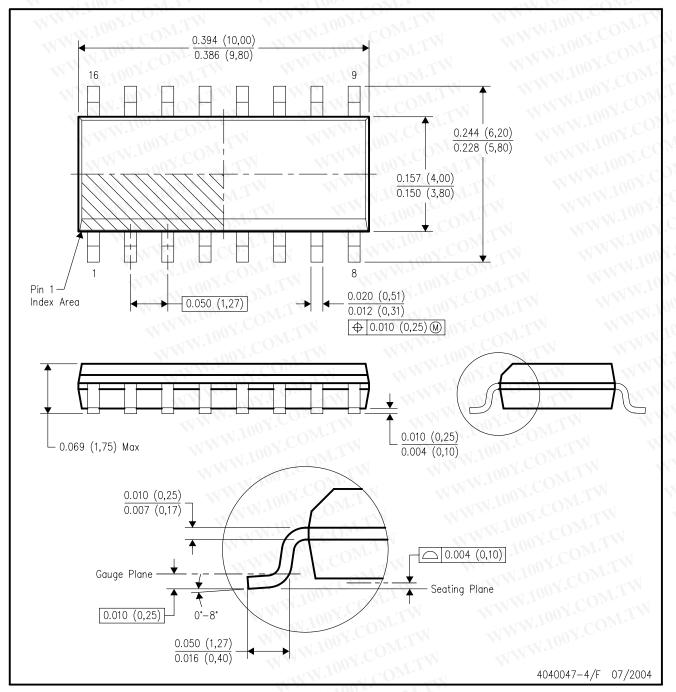
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D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AC.



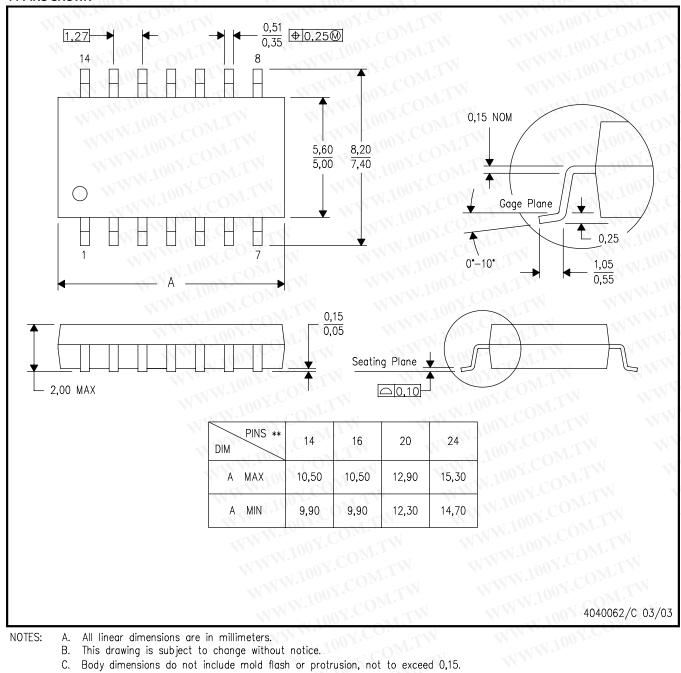


**MECHANICAL DATA** 

## PLASTIC SMALL-OUTLINE PACKAGE

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NS (R-PDSO-G\*\*) **14-PINS SHOWN** 



NOTES: All linear dimensions are in millimeters. Α.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15. WWW.100Y.C

